# 2SD1276, 2SD1276A

# Silicon NPN triple diffusion planar type darlington

## For power amplification

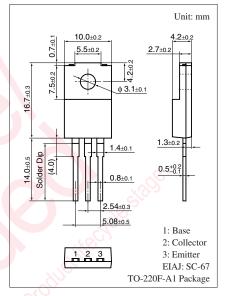
Complementary to 2SB0950 and 2SB0950A

#### Features

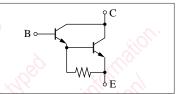
- $\bullet$  High forward current transfer ratio  $h_{FE}$
- High-speed switching
- Full-pack package which can be installed to the heat sink with one screw

## Absolute Maximum Ratings $T_a = 25^{\circ}C$

Parameter	Symbol	Rating	Unit	
Collector-base voltage	2SD1276	V <sub>CBO</sub>	60	V
(Emitter open)	2SD1276A		80	
Collector-emitter voltage	2SD1276	V <sub>CEO</sub>	60	V
(Base open)	2SD1276A		80	
Emitter-base voltage (Collector open)		V <sub>EBO</sub>	5	V
Collector current		I <sub>C</sub>	4	А
Peak collector current		I <sub>CP</sub>	8	А
Collector power	$T_C = 25^{\circ}C$	P <sub>C</sub>	40	W
dissipation			2.0	
Junction temperature		Tj	150	°C
Storage temperature		T <sub>stg</sub>	-55 to +150	°CO



#### Internal Connection



## Electrical Characteristics $T_a = 25^{\circ}C \pm 3^{\circ}C$

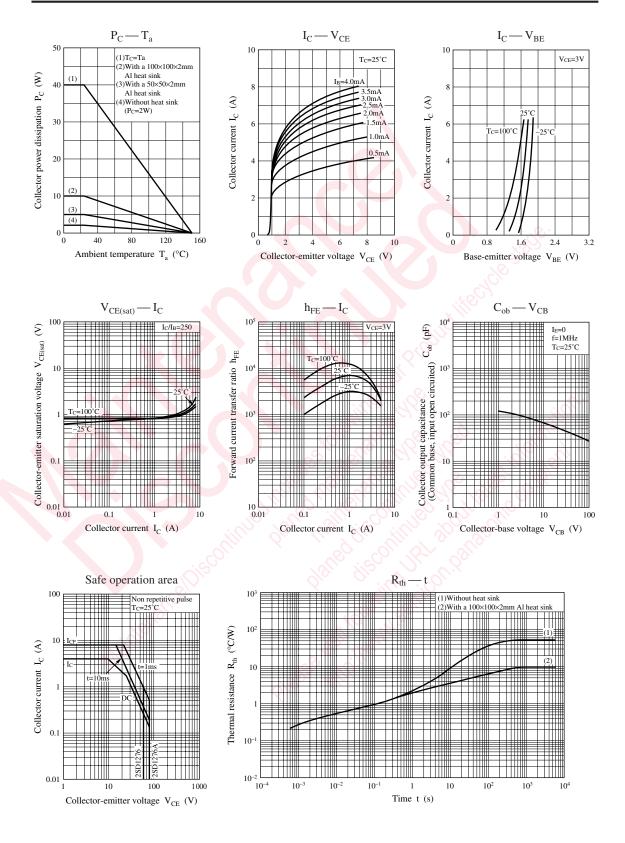
Parameter		Symbol	Conditions	Min	Тур	Max	Unit
Collector-emitter voltage	2SD1276	V <sub>CEO</sub>	$I_{\rm C} = 30 \text{ mA}, I_{\rm B} = 0$	60	2	So.	V
(Base open)	2SD1276A		D CON MILL CON 100	80			
Base-emitter voltage		V <sub>BE</sub>	$V_{CE} = 3 V, I_C = 3 A$	80 a	S	2.5	V
Collector-base cutoff	2SD1276	I <sub>CBO</sub>	$V_{CB} = 60 \text{ V}, I_E = 0$	S.		200	μΑ
current (Emitter open)	2SD1276A		$V_{CB} = 80 V, I_E = 0$	0.7		200	
Collector-emitter cutoff	2SD1276	I <sub>CEO</sub>	$V_{CE} = 30 \text{ V}, I_B = 0$			500	μΑ
current (Base open)	2SD1276A		$V_{CE} = 40 \text{ V}, I_B = 0$			500	
Emitter-base cutoff current (Collector open)		$I_{EBO}$	$V_{EB} = 5 V, I_C = 0$			2	mA
Forward current transfer ratio		$h_{\rm FE1}$	$V_{CE} = 3 V, I_C = 0.5 A$	1 0 0 0			—
		$h_{FE2}$ *	$V_{CE} = 3 V, I_C = 3 A$	1 0 0 0		10000	
Collector-emitter saturation voltage		V <sub>CE(sat)1</sub>	$I_{\rm C} = 3 \text{ A}, I_{\rm B} = 12 \text{ mA}$			2.0	V
		V <sub>CE(sat)2</sub>	$I_{\rm C} = 5 \text{ A}, I_{\rm B} = 20 \text{ mA}$			4.0	
Transition frequency		$f_T$	$V_{CE} = 10 \text{ V}, I_C = 0.5 \text{ A}, f = 1 \text{ MHz}$		20		MHz
Turn-on time		t <sub>on</sub>	$I_C = 3 A, I_{B1} = 12 mA, I_{B2} = -12 mA,$		0.5		μs
Storage time		t <sub>stg</sub>	$V_{CC} = 50 V$		4.0		μs
Fall time		t <sub>f</sub>			1.0		μs

Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7030 measuring methods for transistors. 2. \*: Rank classification

Rank	R	Q	Р
h <sub>FE2</sub>	1000 to 2500	2000 to 5000	4000 to 10000

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# **Panasonic**



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